



Product Change Notification

112141 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #:	112141 - 01
Change Title:	Intel® Ethernet Server Adapter X520-T2(Iron Pond) OEM Gen E10G42BTG1P5 MM#902916 Intel® Ethernet Server Adapter X520-T2 (Iron Pond) Retail E10G42BT MM#902900 Intel®10 Gigabit AT2 Server Adapter (Copper Pond Gen 2) Retail E10G41AT2 MM#903752 Intel® 10 Gigabit AT2 Server Adapter (Copper Pond Gen 2) OEM Gen E10G41AT2G1P5 MM#903753 PCN 112141-01 Documentation, Label ROHS Flyer, Remove CDA (E10G42BT and E10G41AT2) and Update Labels Reason for Revision: Correcting Title & Updating PBA
Date of Publication:	April 08, 2013

Key Characteristics of the Change:

Documentation
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 15, 2013
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Description of Change to the Customer:

Reason for Revision: Correcting Title

The Intel® Ethernet Server Adapter X520-T2 and Intel(R) 10 Gigabit AT2 Server Adapter SKUs listed in the product table below will undergo the following changes:

1. ROHS Flyer

Add or update the China "EU" RoHS flyer to over-pack box. Includes the Intel contact info, per Intel to meet an EU ROHS recast, and now officially called ROHS 2 that goes into effect as of 1/1/2013. In this recast, there is a requirement to include the single point of contact address label for items requiring the "CE" mark.



As part of Intel's efforts to be environmentally responsible,
a CD is no longer included in the box with this adapter.
Download the latest drivers, software, and documentation at:
<http://www.intel.com/support/go/network/adapter/cd.htm>

关于符合中国《电子信息产品污染控制管理办法》的声明
Management Methods on Control of Pollution from Electronic Information Products
(China RoHS declaration)

产品中有毒有害物质的名称及含量

部件名称	有毒有害物质或元素					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr (VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
印刷板组件	×	○	○	○	○	○
○：表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006 标准规定的限量要求以下。 ×：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 标准规定的限量要求。						

For regulatory information go to the user guide:
<http://www.intel.com/support/go/network/adapter/userguide.htm>

For CE Mark-Related Questions:
Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd
Santa Clara, CA 95054-1549
USA

2. CDA Removal (Retail SKUs: E10G42BT and E10G41AT2)

As part of Intel's efforts in environmental responsibility, Intel will no longer include a software CD in the box with the Retail version of Intel® 10 Gigabit AT2 Server Adapter and Intel® Ethernet Converged Network Adapter.

Because of the rapid pace of technology, the software on the CD is usually out of date before the adapter is sold. Drivers that enable basic functionality are included with most operating systems and the latest software, drivers, and documentation are available for download. See ROHS flyer described above.

3. Distribution Label Change

Intel Corp is standardizing packaging label formats across the corporation. This will facilitate easier receiving for the end customer.

Intel will begin implementation of UPC and EAN (European Article Number) codes on the product outer case labels.

The online product catalog (ARK) will be updated with the new UPC & EAN info.

A new line of text will be added that states either:

- Product is individually labeled for resale.
- Product is not individually labeled for resale.

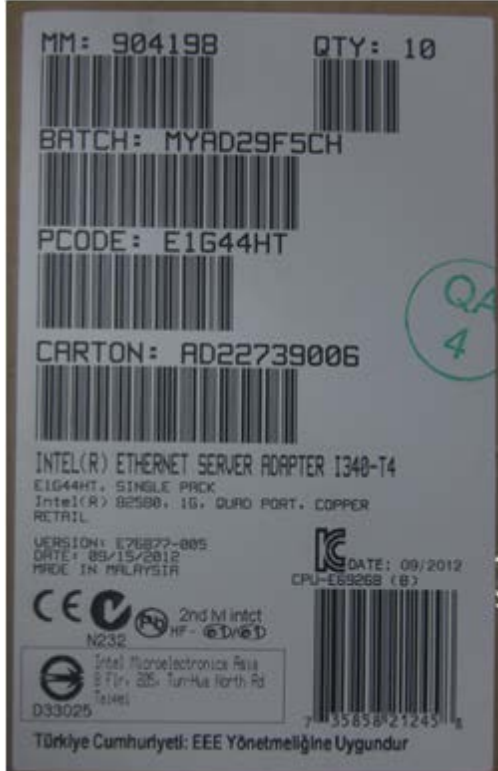
Additional fields are being added to display the outer case UPC and EAN codes for overall carton quantity. New UPC codes for individual boxes are also being added.

2D matrix label will be added for easier product information scanning.

Customers should be aware that UPC and EAN codes on the outer case carton labels will be changed and that they may need to update their incoming receiving operations. Customers may receive both current and new inventory as the implementation occurs.

Product Code	MM#	UPC	EAN	OBL UPC	OBL EAN
E10G42BTG1P5	902916	735858253420	5032037046503		
E10G42BT	902900	735858256391	5032037048682	735858205184	5032037041461
E10G41AT2	903752	735858256346	5032037048637	735858210812	5032037041287
E10G41AT2G1P5	903753	735858253406	5032037046435		

Example of old & new Disti (for over pack boxes) & outer box (for retail single boxes) labels below:

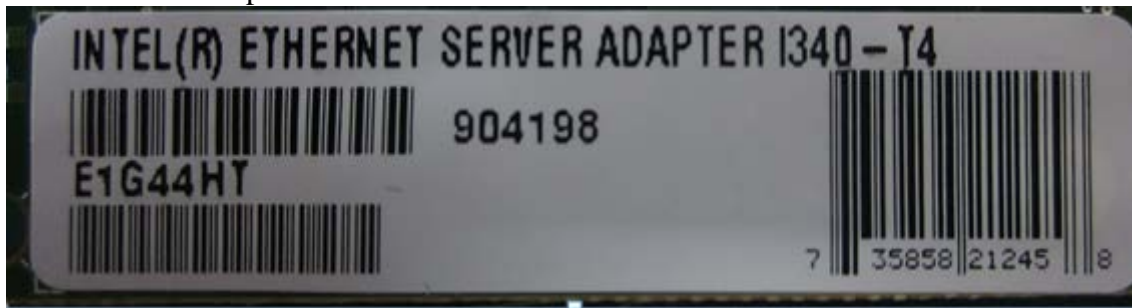
Existing Label (Example only)	New Label (Example only)
 <p>MM: 904198 QTY: 10</p> <p>BATCH: MYAD29F5CH</p> <p>PCODE: E1G44HT</p> <p>CARTON: AD22739006</p> <p>INTEL(R) ETHERNET SERVER ADAPTER 1340-T4 E1G44HT, SINGLE PACK Intel(R) 02580, 1G, DUAL PORT, COPPER RETRIL</p> <p>VERSION: E76B27-005 DATE: 09/15/2012 MADE IN MALAYSIA</p> <p>DATE: 09/2012 CPU-E6926B (B)</p> <p>2nd M Intct HF- @D/@D</p> <p>Intel Microelectronics Asia 8 Fir. 205, Tun-Hua North Rd Taipei</p> <p>Türkiye Cumhuriyeti: EEE Yönetmeliğine Uygundur</p>	<p>Product inside is not labeled for individual resale</p> <p>Product Code: P P P P P P P P P P P P P P P P</p> <p>U E P A C N</p> <p>7 35858 12345 7 0 123456 789128</p> <p>Version: V V V V V V - V V V Date: 10/05/2012</p> <p>MM#: M M M M M M</p> <p>Enclosed S/N's:</p> <p>Batch#: B B B B B B B B B B</p> <p>Carton: C C C C C C C C C C</p> <p>Qty: Q Q Q</p> <p>See supplemental label for individual serial numbers</p> <p>Made in Malaysia</p> <p>Product Description Line 1 Product Description Line 2 Product Description Line 3 Product Description Line 4</p> <p>DATE: M M / V V V V K C C - R E M - C P U - K K K K K K</p> <p>Intel Microelectronics Asia 8 Fir. 205, Tun-Hua North Rd Taipei</p>
 <p>FOLD HERE</p> <p>MM: 914211 INTEL(R) ETHERNET SERVER ADAPTER 1350-F2 1350F2, SINGLE PACK 1350 R1, 1G, DUAL PORT, ADAPTER RETRIL</p> <p>PCODE: 1350F2</p> <p>SN: 01B5A0431A0615814001 MADE IN MALAYSIA</p> <p>VERSION: 626026-001 DATE: 10/20/2011</p> <p>2nd M Intct HF- @D/@D</p> <p>Intel Microelectronics Asia 8 Fir. 205, Tun-Hua North Rd Taipei</p> <p>DATE: 10/2011 K C C - R E M - C P U - 6 2 1 2 8 6</p> <p>Türkiye Cumhuriyeti: EEE Yönetmeliğine Uygundur</p>	<p>Product Description Line 1 Product Description Line 2 Product Description Line 3 Product Description Line 4</p> <p>Version: V V V V V V - V V V Date: 10/05/2012</p> <p>Product Code: P P P P P P P P P P P P P P P P</p> <p>U E MM#: M M M M M M P A N C N</p> <p>7 35858 12345 7 0 123456 789128</p> <p>S/N: S Batch#: B B B B B B B B B B</p> <p>Made in Malaysia</p>

4. Product Label Change

Intel is removing the UPC code on the PBA Product ID label, and using the extra space to incorporate the WEEE and/or eFUP logos onto the Product ID label. The Product ID label is currently placed on either the front or back of the Printed board (PB).

Due to the standardization of UPC codes on the shipping label, the UPC code on the board Product ID label is no longer required, and it will be removed. If applicable, the WEEE and/or EFUP markings (WEEE= Waste Electrical and Electronic Equipment (Directive) and EFUP = Environment Friendly Use Period (China RoHS directive) (currently on separate, individual labels attached to the printed board) will be incorporated on the Product ID label.

Current label example:



New label example:



5. As a result of this change the TA (Top Assembly) and PBA (Printed Board Assembly) numbers will roll as listed in the affected product table below.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	Pre TA Change	Post TA Change	Pre PBA Change	Post PBA Change
Intel® Ethernet Server Adapter X520-T2 (Iron Pond) Retail	E10G42BT	902900	E91920-005	E91920-006	E95990-004	E95990-005
Intel® Ethernet Server Adapter X520-T2 (Iron Pond) OEM Gen	E10G42BTG1P5	902916	E91770-007	E91770-008	E95989-008	E95989-009
Intel® 10 Gigabit AT2 Server Adapter (Copper Pond Gen 2) Retail	E10G41AT2	903752	E72995-006	E72995-007	E73052-005	E73052-006
Intel® 10 Gigabit AT2 Server Adapter (Copper Pond Gen 2) OEM Gen	E10G41AT2G1P5	903753	E72996-005	E72996-006	E55875-008	E55875-009

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
March 29, 2013	00	Originally Published PCN
April 8, 2013	01	Correcting Title & Updating PBA